

November 2, 2004

Ms. Arlene Scarbrough  
SF Products  
P.O. Box 18215  
Atlanta, GA 30316

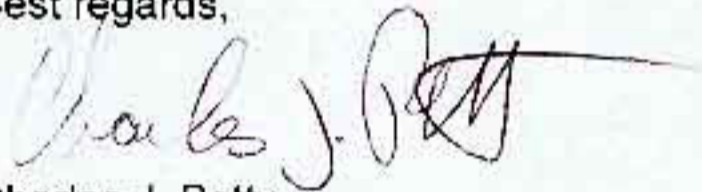
RE: Mold Resistance of ASJ, FSK, and Foil Tapes

Dear Ms. Scarbrough:

The paper side of ASJ and FSK backing used for Compac insulation tapes contain fungicide that enables these products to meet the "no mold growth" requirement of ASTM C1136, *Standard Specification for Low Permeance Vapor Retarders for Thermal Insulation*. The test used for the evaluation is: ASTM C1338, *Standard Test Method for Determining Fungi Resistance of Insulation Materials and Facings*. The aluminum foil side of these tapes, as well as mono-layer foil tapes, do not provide sustenance for mold growth, and are not typically tested.

Please let me know if you have further questions.

Best regards,



Charles J. Petty  
Compac Corporation